

PCN Number:	20130917000		PCN Date:	09/19/2013	
Title:	TPS61165-Q1 datasheet - CMS C1308089				
Customer Contact:	PCN Manager	Phone:	+1(214) 480-6037	Dept:	Quality Services
Change Type:					
<input type="checkbox"/>	Assembly Site	<input type="checkbox"/>	Assembly Process	<input type="checkbox"/>	Assembly Materials
<input type="checkbox"/>	Design	<input checked="" type="checkbox"/>	Electrical Specification	<input type="checkbox"/>	Mechanical Specification
<input type="checkbox"/>	Test Site	<input type="checkbox"/>	Packing/Shipping/Labeling	<input type="checkbox"/>	Test Process
<input type="checkbox"/>	Wafer Bump Site	<input type="checkbox"/>	Wafer Bump Material	<input type="checkbox"/>	Wafer Bump Process
<input type="checkbox"/>	Wafer Fab Site	<input type="checkbox"/>	Wafer Fab Materials	<input type="checkbox"/>	Wafer Fab Process
		<input type="checkbox"/>	Part number change		
PCN Details					
Description of Change:					
Texas Instruments publication SLVSB73 has changed as described below: Page 1 - Changed input voltage range in Features list to breakdown Page 1 - Added automotive cluster backlighting to applications list Page 1 - Changed LED load attachment in typical application image and added C4, R1 and D2 to image Page 17 - Added C4, R1 and D2 to <i>Drive 6 High Brightness LEDs</i> image and manufacturer list					
Reason for Change:					
Make additions and corrections.					
Anticipated impact on Fit, Form, Function, Quality or Reliability (positive / negative):					
No anticipated impact.					
Changes to product identification resulting from this PCN:					
None					
Product Affected:					
TPS61165TDBVRQ1					

For questions regarding this notice, e-mails can be sent to the regional contacts shown below or your local Field Sales Representative.

Location	E-Mail
USA	PCNAmericasContact@list.ti.com
Europe	PCNEuropeContact@list.ti.com
Asia Pacific	PCNAsiaContact@list.ti.com
Japan	PCNJapanContact@list.ti.com